Aspects of ASIC Design

Dr. Pravin Zode

June 17, 2025

Outline

- Introduction
 - Examples of ASICs and Non-ASICs
 - Why ASIC?
- ASIC Classification
 - Full Custom ASIC
 - Semi-Custom ASIC
 - Programmble ASICs
- ASIC Design Flow
- 4 Comparison of FPGA and ASIC



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- Application-Specific Integrated Circuit (ASIC), customized for a particular use, rather than intended for general-purpose use
- Semiconductor industry evolved from first IC in early 1970 and matured rapidly (SSI, LSI, VLSI, ULSI)
- We select some ICs from the catalog and data sheets and purchase them from distributors as **Standard IC**s.
- With the advent of VLSI technology, engineers realize the advantages of Customized or tailored particular system or application rather than Standard IC
- Microelectronic systems are combination of standard function (Std. ICs) with one or more custom ICs

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- **Cryptography Chips**: Designed for encryption and decryption algorithms, such as AES, RSA hardware accelerators.
- Graphics Processing Units (GPUs): Custom-designed ASICs for rendering images and graphics (though some GPUs can be general-purpose, many include ASIC elements).
- Networking Chips: Switches and routers often contain ASICs optimized for handling data packets.
- **Digital Signal Processors (DSPs)**: ASICs used in audio, video, and communication processing applications.
- Automotive Control Units: ASICs specifically designed for controlling various functions in vehicles like ABS, engine management, and infotainment systems.
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- Field-Programmable Gate Arrays (FPGAs): Reconfigurable ICs that can be programmed after manufacturing for various applications.
- **General-Purpose CPUs**: Central Processing Units used in personal computers, servers, and mobile devices.
- Memory Chips (RAM/ROM): ICs used for storing data, with no specific application beyond storage.
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- **Energy Efficiency**: Reduces power consumption by eliminating unnecessary components.
- Compact Size: Custom design leads to smaller, lighter chips.
- **High Speed**: Streamlined architecture enables faster operation.
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- **High Development Costs**: Expensive to design and manufacture, impractical for low-volume production.
- Limited Flexibility: Cannot be reprogrammed once manufactured, unlike FPGAs.
- Long Time to Market: Lengthy design, testing, and manufacturing process.
- Design Complexity: Requires specialized expertise and tools, increasing development effort.
- Risk of Obsolescence: Market or technology changes can render the ASIC obsolete after completion.
- Unsuitable for Prototyping: Lack of flexibility makes ASICs unsuitable for iterative design and testing.

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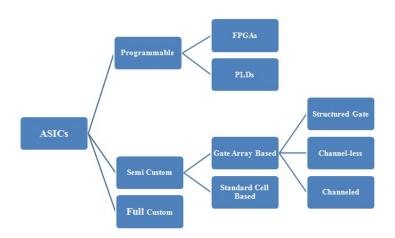
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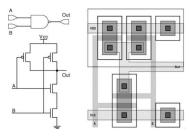
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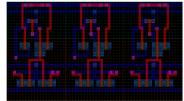
Full-Custom ASIC

Salient Features:

- Every transistor and component is custom-designed for the specific application.
- Offers maximum performance and efficiency.
- Extremely high design cost and complexity.
- Longer time-to-market due to detailed design.
- Used in high-performance applications where power, speed, and area need to be optimized.



NAND Gate

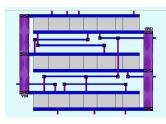


Memory Layout

Semi-Custom ASIC

Salient Features:

- Combines custom-designed components with pre-built standard cells.
- Offers a balance between customization and design time.
- Faster and less expensive to develop compared to full-custom ASICs.
- Standard cells handle common logic functions, while custom blocks handle application-specific tasks.
- Commonly used in industrial and consumer electronics.

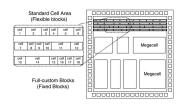


DSP Processor

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Standard Cell Based (CBIC)

- It used predesigned logic cells (AND gates, OR gates, muxes, FF etc..)
- The standard cell areas are built of rows of std. cells like wall built of brick.
- Std. cells may be large predefined cells, (microcontroller) known as megacells/ megafunctions.
- Each cell can be optimized individually.
- Designer save time, money, and reduce risk by using a predefined, pretested, precharacterized std. cell library



- In gate-array based ASICs, the transistors are predefined on the silicon wafer.
- Designers cannot alter the placement of the transistors,
- Designer can change the interconnections between transistors using the die's initial metal layers.
- Following are three types of Gate Array based ASICs
 - Channeled Gate Arrays
 - Channel-less Gate Arrays
 - Structured Gate Arrays

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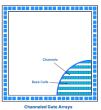
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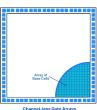
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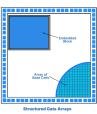
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- Channel-less Gate Arrays: Lack predefined routing channels, allowing more compact designs by placing interconnects directly over cells, enhancing chip density.
- **Structured Gate Arrays:** Combine predefined logic blocks with customizable interconnect layers, offering a balance between design flexibility and rapid development.

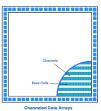


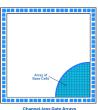


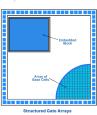


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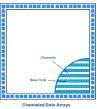


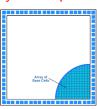


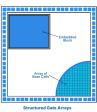


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Salient Features:

- Standardized ASIC designed for a specific application but not for a single customer.
- Pre-designed for large-scale commercial use.
- Limited customization options but highly cost-effective for mass production.
- Faster to market due to standardized design.
- Commonly used in consumer electronics, networking devices, and automotive systems.

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- ASICs that allow for configuration and reconfiguration after manufacturing.
- Types:
 - FPGAs (Field-Programmable Gate Arrays):
 - CPLDs (Complex Programmable Logic Devices)

- Advantages:
 - Rapid prototyping and design iterations
 - Flexibility to update designs post-production
 - Cost-effective for low to medium volume applications
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- Types:
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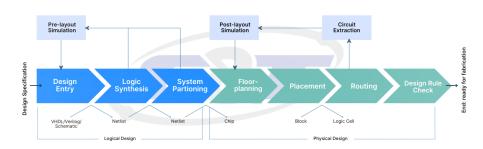
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- 2 ASIC Classification
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 - Semi-Custom ASIC
 - Programmble ASICs
- 3 ASIC Design Flow
- 4 Comparison of FPGA and ASIC

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ASIC Design Flow



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¹source: https://www.candtsolution.com

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Comparison of FPGA and ASIC

Table 1: Comparison of FPGA and ASIC Features

Feature	FPGA	ASIC
Flexibility	High (reprogrammable)	Low (not reprogrammable)
Performance	Lower than ASIC	Higher performance for specific tasks
Power Consumption	Higher compared to ASIC	Lower (optimized for efficiency)
Development Cost	Low (no NRE cost)	High (high NRE cost)
Production Cost per Unit	Higher compared to ASIC	Lower (optimized for efficiency)
Time to Market	Shorter (reprogrammable, adaptable)	Longer (due to design and fabrication)
Reprogrammability	Yes (can change algorithms post-production)	No (fixed design)
Suitable Production Cycle	Small to medium scale	High volume (to offset NRE costs)
Design Cycle	Shorter	Longer

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Thank You